

JOURNAL OF ALLOYS AND COMPOUNDS

(Formerly Journal of the Less-Common Metals)

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Publication information: *Journal of Alloys and Compounds* (ISSN 0925-8388). For 2012, volumes 510-545 are scheduled for publication. Subscription prices are available upon request from the Publisher or from the Elsevier Customer Service Department nearest you or from this journal's website (<http://www.elsevier.com/locate/jalcom>). Further information is available on this journal and other Elsevier products through Elsevier's website (<http://www.elsevier.com>). Subscriptions are accepted on a prepaid basis only and are entered on a calendar year basis.

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